- 4 "PI-2570"  - 2 release with "polyimide parylene"  - 219288 peel\$  - 121512 polyimide parylene  - 1029 release with (polyimide parylene)  - 1029 release with (polyimide parylene)  - 7683345 layer material film  - 7948347 (layer material film ) coating	SPAT; S-PGPUB; O; JPO; RWENT; M_TDB SPAT; S-PGPUB; O; JPO; RWENT; M_TDB SPAT; S-PGPUB; O; JPO; RWENT; M_TDB SPAT; M_TDB SPAT; S-PGPUB; O; JPO; RWENT; M_TDB SPAT; M_TDB	2003/11/03 19:58 2003/11/03 20:11 2003/11/03 20:41 2003/11/03 20:41 2003/11/03 20:42
- 4 "PI-2570"  - 2 release with "polyimide parylene"  - 219288 peel\$  - 121512 polyimide parylene  - 1029 release with (polyimide parylene)  - 1029 release with (polyimide parylene)  - 7683345 layer material film  - 7948347 (layer material film ) coating  - 7948347 (layer material film ) coating	S-PGPUB; OC; JPO; PRWENT; M_TDB S-PGPUB; OC; JPO; FRWENT; M_TDB S-PGPUB; OC; JPO; FRWENT; M_TDB S-PGPUB; OC; JPO; FRWENT; M_TDB S-PGPUB; OC; JPO; FRWENT; M_TDB S-PGPUB; OC; JPO; FRWENT; M_TDB	19:58  2003/11/03 20:11  2003/11/03 20:41  2003/11/03 20:41  2003/11/03 20:42
- 4 "PI-2570"  - 2 release with "polyimide parylene"  - 219288 peel\$  - 121512 polyimide parylene  - 1029 release with (polyimide parylene)  - 1029 release with (polyimide parylene)  - 7683345 layer material film  - 7948347 (layer material film ) coating    Document   Docume	RWENT; M_TDB SPAT; S-PGPUB; O; JPO; RWENT; M_TDB SPAT; S-PGPUB; O; JPO; REWENT; M_TDB SS-PGPUB; O; JPO; REWENT; M_TDB SS-PGPUB; O; JPO; SS-PGFUB; O; JPO; SS	2003/11/03 20:41 2003/11/03 20:41 2003/11/03 20:42
- 4 "PI-2570"  - 2 release with "polyimide parylene"  - 219288 peel\$  - 121512 polyimide parylene  - 1029 release with (polyimide parylene)  - 1029 release with (polyimide parylene)  - 7683345 layer material film  - 7948347 (layer material film ) coating	M_TDB SPAT; SPCGPUB; OC; JPO; ERWENT; M_TDB SPAT; SOC; JPO; ERWENT; M_TDB SPAT; SPGPUB; OC; JPO; ERWENT; M_TDB SPAT; SPCGPUB; OC; JPO; ERWENT; M_TDB SPAT; SPCGPUB; OC; JPO; ERWENT; M_TDB	2003/11/03 20:41 2003/11/03 20:41 2003/11/03 20:42
- 4 "PI-2570"  US FF DI IB IB Telease with "polyimide parylene"  - 219288 peel\$  US US FF DI IB IB US FF DI IB US FF DI IB US FF DI IB US FF DI IB	SPAT; S-PGPUB; O; JPO; S-PGPUB; O; JPO; S-PGPUB;	2003/11/03 20:41 2003/11/03 20:41 2003/11/03 20:42
- 219288 peel\$ US - 219288 peel\$ US - 121512 polyimide parylene - 1029 release with (polyimide parylene) - 1029 release with (polyimide parylene) - 7683345 layer material film - 7948347 (layer material film ) coating US - 7948347 (layer material film ) coating US - 1029 US - 1029 release with (polyimide parylene)	S-PGPUB; O; JPO; ERWENT; M_TDB SPAT; S-PGPUB; O; JPO; ERWENT; M_TDB SPAT; S-PGPUB; O; JPO;	2003/11/03 20:41 2003/11/03 20:41 2003/11/03 20:42
- 219288 peel\$  - 219288 peel\$  - 121512 polyimide parylene  - 1029 release with (polyimide parylene)  - 1029 release with (polyimide parylene)  - 7683345 layer material film  - 7948347 (layer material film ) coating    EFF	O; JPO; RWENT; M_TDB SPAT; S-PGPUB; OC; JPO; RWENT; M_TDB SPAT; S-PGPUB; O; JPO; RWENT; M_TDB SPAT; S-PGPUB; O; JPO; RWENT; M_TDB	2003/11/03 20:41 2003/11/03 20:41 2003/11/03 20:42
- 219288 peel\$ US - 219288 peel\$ US - 121512 polyimide parylene - 1209 release with "polyimide parylene - 1029 release with (polyimide parylene) - 7683345 layer material film - 7948347 (layer material film ) coating US - 7948347 (layer material film ) coating	ERWENT; M_TDB SPAT; S-PGPUB; O; JPO; ERWENT; M_TDB	2003/11/03 20:41 2003/11/03 20:42
- 2 release with "polyimide parylene"  - 219288 peel\$  - 121512 polyimide parylene  - 1029 release with (polyimide parylene)  - 1029 release with (polyimide parylene)  - 7683345 layer material film  - 7948347 (layer material film ) coating  US	M_TDB  SPAT;  S-PGPUB;  O; JPO;  ERWENT;  M_TDB	2003/11/03 20:41 2003/11/03 20:42
- 219288 peel\$ US - 219288 peel\$ US - 121512 polyimide parylene - 1029 release with (polyimide parylene) - 1029 release with (polyimide parylene) - 7683345 layer material film - 7948347 (layer material film ) coating US - 194847 US - 194847 US - 19484847 (layer material film ) coating US - 19484847 US - 19484847 US - 19484847 US - 19484848 US - 194848 US - 19484	GPAT; GPAT; GPGPUB; GPO; GPO; GPO; GPO; GPO; GPO; GPO; GPO	2003/11/03 20:41 2003/11/03 20:42
- 219288 peel\$ US - 121512 polyimide parylene - 1029 release with (polyimide parylene) - 1029 release with (polyimide parylene) - 7683345 layer material film - 7948347 (layer material film ) coating US - 7948347 (layer material film ) coating US	S-PGPUB; O; JPO; ERWENT; M_TDB SPAT; S-PGPUB; O; JPO; ERWENT; M_TDB SPAT; S-PGPUB; O; JPO; ERWENT; M_TDB	2003/11/03 20:41 2003/11/03 20:42
- 219288 peel\$ US - 121512 polyimide parylene US - 1029 release with (polyimide parylene) US - 7683345 layer material film US - 7948347 (layer material film ) coating US - FER STANDARD STANDAR	PO; JPO; ERWENT; M_TDB SPAT; S-PGPUB; O; JPO; ERWENT; M_TDB SPAT; S-PGPUB; OC; JPO; ERWENT; M_TDB	2003/11/03 20:41 2003/11/03 20:42
- 219288 peel\$ US IB	ERWENT; M_TDB SPAT; S-PGPUB; O; JPO; ERWENT; M_TDB SPAT; S-PGPUB; OO; JPO; ERWENT; M_TDB	20:41 2003/11/03 20:42
- 219288 peel\$  US FF DI US US FF DI US US US FF DI US US US FF DI US US US US US FF DI US US US EF DI US US US EF EF DI US US EF EF DI US US EF EF DI US US EF EF US US US EF EF US US US US EF EF US US US US EF EF US US US US US US US US EF EF US	M_TDB SPAT; 5-PGPUB; O; JPO; ERWENT; M_TDB SPAT; 5-PGPUB; O; JPO; ERWENT; M_TDB	20:41 2003/11/03 20:42
- 121512 polyimide parylene US - 121512 polyimide parylene US - 1029 release with (polyimide parylene) - 7683345 layer material film US - 7948347 (layer material film ) coating US - 7948347 (layer material film ) coating	GPAT; 5-PGPUB; 6-C; JPO; ERWENT; M_TDB GPAT; 6-PGPUB; 6-PGPUB; FO; JPO; ERWENT; M_TDB	20:41 2003/11/03 20:42
- 121512 polyimide parylene US - 1029 release with (polyimide parylene) US - 7683345 layer material film US - 7948347 (layer material film ) coating US - 1029 release with (polyimide parylene) US	S-PGPUB; PO; JPO; ERWENT; M_TDB SPAT; S-PGPUB; PO; JPO; ERWENT; M_TDB	20:41 2003/11/03 20:42
- 121512 polyimide parylene US  - 1029 release with (polyimide parylene)  - 7683345 layer material film  - 7948347 (layer material film ) coating  US  EF  Di  IB  IB  IB  IB  IB  IB  IB  IB  IB  I	PO; JPO; ERWENT; M_TDB SPAT; S-PGPUB; PO; JPO; ERWENT; M_TDB	2003/11/03 20:42
- 121512 polyimide parylene US EF 1029 release with (polyimide parylene)  - 1029 release with (polyimide parylene) US EF D I IB US EF EF I IB US EF EF I IB US EF	ERWENT; M_TDB SPAT; S-PGPUB; PO; JPO; ERWENT; M_TDB	20:42
- 121512 polyimide parylene US EF FO Do O IB	M_TDB SPAT; S-PGPUB; PO; JPO; ERWENT; M_TDB	20:42
- 121512 polyimide parylene US EF EF DO 1188	SPAT; S-PGPUB; PO; JPO; ERWENT; M_TDB	20:42
- 1029 release with (polyimide parylene)  - 1029 release with (polyimide parylene)  - 7683345 layer material film  - 7948347 (layer material film ) coating  US  EFF  US  US  EFF  EFF	S-PGPUB; PO; JPO; ERWENT; M_TDB	20:42
- 1029 release with (polyimide parylene)  USUSER FER DITERIOR OF THE PROPERTY	O; JPO; RWENT; M_TDB	
- 1029 release with (polyimide parylene) US FER FOR TOR TORS  - 7683345 layer material film US FER FOR TOR TOR TOR TOR TOR TOR TOR TOR TOR T	RWENT; M_TDB	2003/11/03
- 1029 release with (polyimide parylene) US EF DI TIB TIB TIB TIB TIB TIB TIB TIB TIB TI	M_TDB	2003/11/03
- 1029 release with (polyimide parylene) US US EF D I I I I I I I I I I I I I I I I I I		2003/11/03
- 7683345 layer material film US - 7948347 (layer material film ) coating US - 1948347 US		
- 7683345 layer material film U.U.E.F.F.   18	S-PGPUB;	20:42
- 7683345 layer material film US EFF   10   10   10   10   10   10   10	O; JPO;	20.42
- 7683345 layer material film US US EF DI IB IB US (layer material film ) coating US EF EF COATION COATION US EF EF COATION COATION US EF COATION COATION COATION US EF COATION COATIO	ERWENT;	
- 7683345 layer material film US EF DI IB	M_TDB	İ
US	SPAT;	2003/11/03
- 7948347 (layer material film ) coating US	S-PGPUB;	20:43
- 7948347 (layer material film ) coating US	O; JPO;	20.43
- 7948347 (layer material film ) coating US	RWENT;	
- 7948347 (layer material film ) coating US US US	M_TDB	
US	SPAT;	2003/11/03
EF	-PGPUB;	20:46
Di	O; JPO;	
	RWENT;	1
I IB	M_TDB	1
<ul> <li>412 (release adj ((layer material film ) coating)) with US</li> </ul>	SPAT;	2003/11/03
	5-PGPUB;	20:48
	O; JPO;	1
	ERWENT;	{
	M_TDB	
	SPAT;	2003/11/03
	S-PGPUB;	20:50
	O; JPO;	1
	RWENT;	1
	M_TDB	2002/11/02
	SPAT;	2003/11/03
	5-PGPUB;	20:50
	0. 100.	i
	O; JPO;	1
	RWENT;	2002/11/02
	RWENT; M_TDB	2003/11/03
	RWENT; M_TDB SPAT;	
	ERWENT; M_TDB SPAT; S-PGPUB;	20:51
IB	RWENT; M_TDB SPAT;	20:51

-	1427	(polyimide parylene) with (platinum pt palladium pd)	USPAT; US-PGPUB;	2003/11/03 20:51
1		pa)	EPO; JPO;	20.31
ł	1		DERWENT;	1
l .	1		IBM_TDB	1
-	5	release with ((polyimide parylene) with	USPAT;	2003/11/03
l .		(platinum pt palladium pd))	US-PGPUB;	20:52
l		(t	EPO; JPO;	
l			DERWENT;	
l			IBM_TDB	
-	4	(release with ((polyimide parylene) with	USPAT;	2003/11/03
Ì		(platinum pt palladium pd))) not	US-PGPUB;	20:52
1	1	(@ad>19990825 @rlad>19990825	EPO; JPO;	
		@pt1d>19990825)	DERWENT;	1
1			IBM_TDB	
-	23	peel\$ with ((polyimide parylene) with (platinum	USPAT;	2003/11/03
}		pt palladium pd))	US-PGPUB;	20:53
ļ			EPO; JPO;	
į.	1		DERWENT;	
1	18	(peel\$ with ((polyimide parylene) with (platinum	IBM_TDB USPAT;	2003/11/03
1 -	10	pt palladium pd))) not (@ad>19990825	US-PGPUB;	20:53
l		@rlad>19990825 @pt1d>19990825)	EPO; JPO;	20.33
l	1	@.idds 13330053 @bt1ds 13330053)	DERWENT;	
			IBM TDB	l
i -	162	((release adj ((layer material film ) coating))	USPAT;	2003/11/03
1	10-	near5 (polyimide parylene)) not	US-PGPUB;	20:57
1	Ì	(@ad>19990825 @rlad>19990825	EPO; JPO;	
1	1	@pt1d>19990825)	DERWENT;	
1	}		IBM_TDB	
-	122590	photoresist	USPAT;	2003/11/03
1			US-PGPUB;	20:57
[			EPO; JPO;	
Į.			DERWENT;	
Į.	9	(// 1 // // // // // // // // /	IBM_TDB	2002/44/02
1 -	9	(((release adj ((layer material film ) coating)) near5 (polyimide parylene)) not	USPAT; US-PGPUB;	2003/11/03 21:10
l		(@ad>19990825 @rlad>19990825	EPO; JPO;	21.10
1		@pt1d>19990825)) with photoresist	DERWENT;	
1		aperas 15550025// mail photoresist	IBM_TDB	
l -	٥ ا	pirl with (platinum pt palladium pd)	USPAT;	2003/11/03
1	1	the same of the sa	US-PGPUB;	21:10
1	1		EPO; JPO;	
1	1		DERWENT;	
1	1		IBM_TDB	
-	180	pirl	USPAT;	2003/11/03
1	1		US-PGPUB;	21:10
1	1		EPO; JPO;	
1	1		DERWENT;	
1	157	-id (@-d- 4000003F @-d-d- 4000003F	IBM_TDB	2002/11/02
l -	15/	pirl not (@ad>19990825 @rlad>19990825   @pt1d>19990825)	USPAT; US-PGPUB;	2003/11/03
!	l	@pt1u>13330023)	EPO; JPO;	21.11
l			DERWENT;	
l			IBM_TDB	
-	13	pirl with photoresist	USPAT;	2003/11/03
I	1		US-PGPUB;	21:17
1	1		EPO; JPO;	
1	ì		DERWENT;	
L	L	L	IBM_TDB	

-	13	(pirl with photoresist) not (@ad>19990825	USPAT;	2003/11/04
ļ	į.	@rlad>19990825 @pt1d>19990825)	US-PGPUB:	19:50
1			EPO; JPO;	
	ļ.		DERWENT;	ļ
			IBM_TDB	
l -	33798	release adj ((layer material film ) coating)	USPAT;	2003/11/04
	00770	release day ((layer material lilling)	US-PGPUB;	21:28
1			EPO; JPO;	21.20
			DERWENT;	
	1			l ì
	309	(alabia, as as a all adi, as a d)ibb (asla a a a di	IBM_TDB	2003/11/04
1 -	309	(platinum pt palladium pd) with (release adj	USPAT;	
	1	((layer material film ) coating))	US-PGPUB;	21:28
			EPO; JPO;	1
	Į		DERWENT;	
ļ			IBM_TDB	
-	1	((platinum pt palladium pd) with (release adj	USPAT;	2003/11/04
		((layer material film ) coating))) with etch\$	US-PGPUB;	21:30
1	i .		EPO; JPO;	
i	I		DERWENT;	
	1		IBM_TDB	
-	958156	release	USPAT;	2003/11/04
1	i		US-PGPUB;	21:31
	1		EPO; JPO;	
1	I		DERWENT;	
	l		IBM_TDB	
l -	1457450	platinum pt palladium pd	USPAT;	2003/11/04
			US-PGPUB;	21:31
			EPO; JPO;	
1	1		DERWENT;	1
			IBM TDB	
-	453729	etch\$	USPAT;	2003/11/04
	1007.23	340114	US-PGPUB;	21:31
	ì		EPO; JPO;	1 -1.51
			DERWENT;	
			IBM_TDB	
_	5907	(platinum pt palladium pd) with etch\$	USPAT;	2003/11/04
İ	3307	(placifical) pe palladidili pa) with etcily	US-PGPUB:	21:31
	ļ		EPO; JPO;	21.51
i			DERWENT; IBM_TDB	
1.	6	release with ((platinum at palladium ad)ith		2002/11/04
1-	۰ ۱	release with ((platinum pt palladium pd) with	USPAT;	2003/11/04 21:31
		etch\$)	US-PGPUB;	21:31
	1		EPO; JPO;	
	1		DERWENT;	
	774	(alabiaa ab aalladi ad) aaaab b	IBM_TDB	2002/11/04
1 -	774	(platinum pt palladium pd) near etch\$	USPAT;	2003/11/04
1			US-PGPUB;	21:37
1			EPO; JPO;	
1	1		DERWENT;	
i	1		IBM_TDB	
1 -	2	("4784972").PN.	USPAT;	2003/11/06
1	)		US-PGPUB;	21:33
			EPO; JPO;	
1	1		DERWENT;	]
			IBM_TDB	
-	6	005633.ap.	USPAT;	2003/11/07
			US-PGPUB;	18:33
			EPO; JPO;	
			DERWENT;	
L			IBM_TDB	

·	1457909	platinum pd palladium pt	USPAT;	2003/11/07
1	2107707	placificant pa panadiam pe	US-PGPUB:	19:28
1			EPO; JPO;	
l	l i		DERWENT:	
			IBM TDB	
-	0	(platinum pd palladium pt) and	USPAT;	2003/11/07
1	i	(("5665648").PN.)	US-PGPUB;	19:29
			EPO; JPO;	
			DERWENT;	1
1			IBM_TDB	
-	2	("5665648").PN.	USPAT;	2003/11/07
}			US-PGPUB;	20:50
			EPO; JPO;	
1			DERWENT;	
1	:		IBM_TDB	
-	17	tape! adj automated adj bonding adj carrier	USPAT;	2003/11/07
1			US-PGPUB;	20:51
1			EPO; JPO;	1
			DERWENT;	
	L	L	_IBM_TDB	l